

Philips Semiconductors

Product specification

BU4507DF

Silicon Diffused Power Transistor

GENERAL DESCRIPTION

Enhanced performance, new generation, high-voltage, high-speed switching npn transistor in a plastic full-pack envelope with an integrated damper diode intended for use in horizontal deflection circuits of colour television receivers and computer monitors. Features exceptional tolerance to base drive and collector current load variations resulting in a very low worst case dissipation.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$\begin{array}{c} V_{CESM} \\ V_{CEO} \\ I_C \\ I_{CM} \\ P_{tot} \\ V_{CEsat} \\ I_{Csat} \\ V_F \\ t_f \end{array}$	Collector-emitter voltage peak value Collector-emitter voltage (open base) Collector current (DC) Collector current peak value Total power dissipation Collector-emitter saturation voltage Collector saturation current Diode forward voltage Fall time	$V_{BE} = 0 V$ $T_{hs} \le 25 \ ^{\circ}C$ $I_{C} = 4 \ A; I_{B} = 1.0 \ A$ f = 16kHz $I_{F} = 4 \ A$ $I_{Csat} = 4 \ A; f = 16kHz$	- - - 4 1.7 300	1500 800 8 15 45 3.0 - 2.1 400	V A A W V A V ns

PINNING - SOT199

base

collector

emitter

isolated

DESCRIPTION

PIN

1

2

3

case

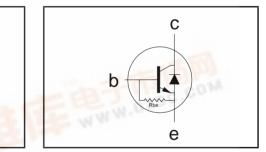
PIN CONFIGURATION

1 2 3

 \bigcirc

case

SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0 V$	-	1500	V
V _{CEO}	Collector-emitter voltage (open base)		-	800	V
	Collector current (DC)		1 200	8	Α
I _{CM}	Collector current peak value		C . V	15	Α
I I _B	Base current (DC)	and the	L OL	4	A
I _{BM}	Base current peak value	WW.	10.0	6	A
-I _{BM}	Reverse base current peak value ¹		-	5	Α
P _{tot}	Total power dissipation	$T_{hs} \leq 25 \degree C$	-	45	W
T _{sta}	Storage temperature		-65	150	°C
	Junction temperature		-	150	°C

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
R _{th j-hs}	Junction to heatsink	with heatsink compound	-	2.8	K/W
R _{th j-a}	Junction to ambient	in free air	35	-	K/W



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ISOLATION LIMITING VALUE & CHARACTERISTIC

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	Repetitive peak voltage from all three terminals to external heatsink	$R.H. \leq 65~\%$; clean and dustfree	-	-	2500	V
C _{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	-	22	-	pF

STATIC CHARACTERISTICS

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CES}	Collector cut-off current ²	$V_{BE} = 0 V; V_{CE} = V_{CESMmax}$	-	-	1.0	mA
ICES		$V_{BE} = 0 V; V_{CE} = V_{CESMmax}$ $V_{BE} = 0 V; V_{CE} = V_{CESMmax}$	-	-	2.0	mA
V_{CEOsust}	Collector-emitter sustaining voltage	T _j = 125 °C I _B = 0 A; I _C = 100 mA; L = 25 mH	800	-	-	V
BV_{EBO}	Emitter-base breakdown voltage	$I_{B} = 600 \text{ mA}$	7.5	13.5	-	V
R _{be}	Base-emitter resistance	$\overline{V}_{EB} = 6 V$	-	30	-	Ω
V _{CEsat}	Collector-emitter saturation voltages	$I_{c} = 4 \text{ A}; I_{B} = 1.0 \text{ A}$	-	-	3.0	V
V _{BEsat}	Base-emitter saturation voltage	$I_{\rm C} = 4 \text{A}; I_{\rm B} = 1.0 \text{A}$	0.83	0.92	1.01	V
h _{FE}	DC current gain	$I_{c} = 500 \text{ mA}; V_{cr} = 5 \text{ V}$	-	7	-	
		$I_{c}^{\circ} = 500 \text{ mA}; V_{ce} = 5 \text{ V}$ $I_{c} = 4 \text{ A}; V_{ce} = 5 \text{ V}$	4.2	5.7	7.3	
h _{fe} V _f	Diode forward voltage	$I_F = 4 A$	-	1.7	2.1	V

DYNAMIC CHARACTERISTICS

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
t _s t _f	Switching times (16 kHz line deflection circuit) Turn-off storage time Turn-off fall time	$I_{Csat} = 4 \text{ A}; I_{B1} = 0.8 \text{ A}; (I_{B2} = -2 \text{ A})$	3.7 300	4.6 400	μs ns
V _{fr} t _{fr}	Anti-parallel diode forward recovery voltage Anti-parallel diode forward recovery time	$I_F = 4 \text{ A}; dI_F/dt = 50 \text{ A/}\mu\text{s}$ $V_F = 5 \text{ V}$	18.5 500	-	V ns

² Measured with half sine-wave voltage (curve tracer).

IC

IВ

VCE

IC

ΙB

۱_F

V F

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– ICsat + 150 v nominal TRANSISTOR adjust for ICsat DIODE t 000000 1c IB1 t D.U.T. 20us 26us IB2 LΒ IBend Cfb 64us 000000 **1**,≹ -C -VBB Rbe t Fig.1. Switching times waveforms (16 kHz). Fig.4. Switching times test circuit. 100 ^{hFE} ICsat 90 % Ths = 25 C Ths = 85 C 10 % 10 t ts IB1 t 0.01 - IB2 IC / A 10 0.1 1 Fig.5. High and low DC current gain. Fig.2. Switching times definitions. 100 L ۱_F Ths = 25 C Ths = 85 C 10% time t fr 10 ν 5 V fr V F 4 0.01

Fig.3. Definition of anti-parallel diode V_{fr} and t_{fr}.

time

Fig.6. High and low DC current gain.

IC / A

10

0.1

BU4507DF

6

4

2

0 ∟ 0

Fig.9.

0.5

1

1.5

Typical collector storage and fall time. $I_c = 4 A$; $T_j = 85^{\circ}C$; f = 16 kHz

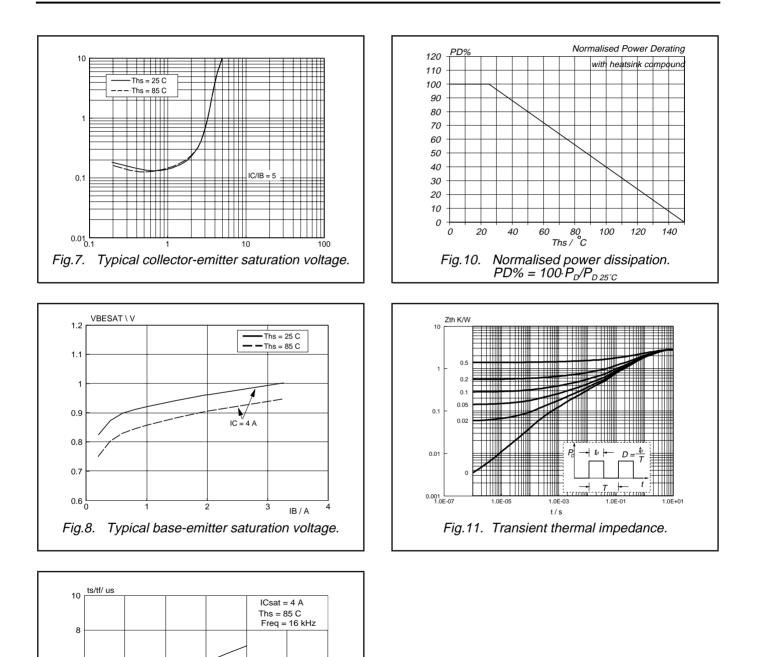
2

2.5 B / A 3

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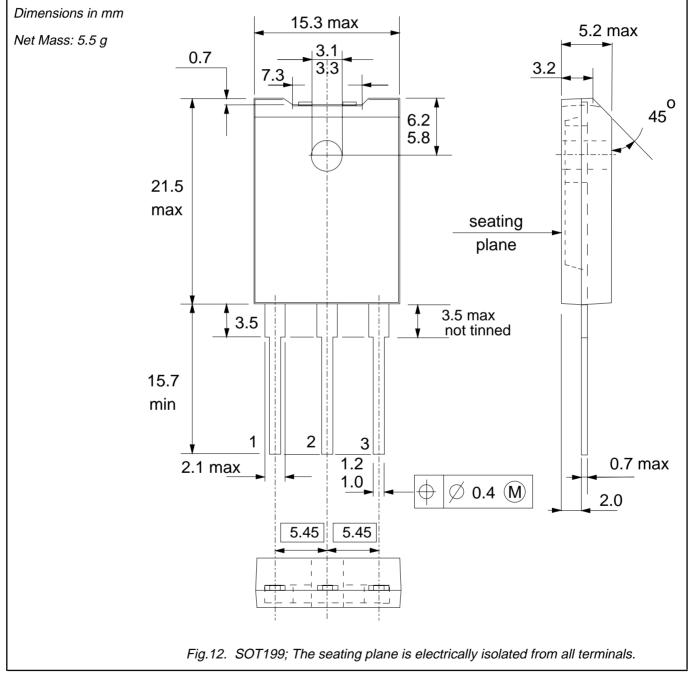


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MECHANICAL DATA



Notes

Refer to mounting instructions for F-pack envelopes.
Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status				
Objective specification	bjective specification This data sheet contains target or goal specifications for product development.			
Preliminary specification	eliminary specification This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	duct specification This data sheet contains final product specifications.			
Limiting values				
or more of the limiting val operation of the device at	in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one ues may cause permanent damage to the device. These are stress ratings only and these or at any other conditions above those given in the Characteristics sections of applied. Exposure to limiting values for extended periods may affect device reliability.			
••	ation is given, it is advisory and does not form part of the specification.			
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